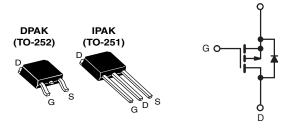


IRFR9220, IRFU9220, SiHFR9220, SiHFU9220

Vishay Siliconix

Power MOSFET

| PRODUCT SUMMARY | | | | | | |
|----------------------------|------------------------------|--|--|--|--|--|
| V _{DS} (V) | - 200 | | | | | |
| R _{DS(on)} (Ω) | V _{GS} = - 10 V 1.5 | | | | | |
| Q _g (Max.) (nC) | 20 | | | | | |
| Q _{gs} (nC) | 3.3 | | | | | |
| Q _{gd} (nC) | 11 | | | | | |
| Configuration | Single | | | | | |



P-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Surface Mount (IRFR9220, SiHFR9220)
- Straight Lead (IRFUFU9220, SiHFU9220)
- Available in Tape and Reel
- P-Channel
- Fast Switching
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

Third power MOSFETs technology is the key to Vishay advanced line of Power MOSFET transistors. The efficient geometry and unique processing of the Power MOSFETs design achieve very low on-state resistance combined with high transconductance and extreme device ruggedness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

| ORDERING INFORMATION | | | | | | | | |
|------------------------------------|---------------|-----------------------------|-----------------------------|----------------------------|---------------|--|--|--|
| Package | DPAK (TO-252) | DPAK (TO-252) | DPAK (TO-252) | DPAK (TO-252) | IPAK (TO-251) | | | |
| Lead (Pb)-free and Halogen-free | SiHFR9220-GE3 | SiHFR9220TRL-GE3ª | SiHFR9220TRR-GE3ª | SiHFR9220TR-GE3ª | SiHFU9220-GE3 | | | |
| Lead (Pb)-free | IRFR9220PbF | IRFR9220TRLPbFa | IRFR9220TRRPbF ^a | IRFR9220TRPbF ^a | IRFU9220PbF | | | |
| | SiHFR9220-E3 | SiHFR9220TL-E3 ^a | SiHFR9220TR-E3 ^a | SiHFR9220T-E3 ^a | SiHFU9220-E3 | | | |

Note

a. See device orientation.

| PARAMETER | | | SYMBOL | LIMIT | UNIT |
|---|------------------|-----------------------------------|-----------------|-------|------|
| Drain-Source Voltage | | V _{DS} | - 200 | v | |
| Gate-Source Voltage | | | V _{GS} | ± 20 | v |
| Continuous Drain Current | – I _D | - 3.6 | | | |
| Continuous Drain Current | I _D | - 2.3 | А | | |
| Pulsed Drain Current ^a | | | I _{DM} | - 14 | |
| Linear Derating Factor | | | 0.33 | M/90 | |
| Linear Derating Factor (PCB Mount) ^e | | | 0.020 | W/°C | |
| Single Pulse Avalanche Energy ^b | | E _{AS} | 310 | mJ | |
| Repetitive Avalanche Current ^a | | | I _{AR} | - 3.6 | А |
| Repetitive Avalanche Energy ^a | | | E _{AR} | 4.2 | mJ |
| Maximum Power Dissipation | 5 °C | D | 42 | w | |
| Maximum Power Dissipation (PCB Mount)e | P _D | 2.5 | v | | |
| Peak Diode Recovery dV/dt ^c | dV/dt | - 5.0 | V/ns | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to + 150 | °C | |
| Soldering Recommendations (Peak Temperature) ^d | 0 s | | 260 | | |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

 $\begin{array}{l} V_{DD} = -50 \text{ V}, \text{ Starting } T_J = 25 \ ^\circ\text{C}, \ L = 35 \ ^\text{mH}, \ R_g = 25 \ \Omega, \ I_{AS} = -3.6 \ \text{A} \ (\text{see fig. 12}). \\ I_{SD} \leq -3.9 \ \text{A}, \ dI/dt \leq 95 \ ^\text{A}/\mu\text{s}, \ V_{DD} \leq V_{DS}, \ T_J \leq 150 \ ^\circ\text{C}. \end{array}$ b.

c.

d.

When mounted on 1" square PCB (FR-4 or G-10 material). e.

S13-0166-Rev. E, 04-Feb-13

Available



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| THERMAL RESISTANCE RATINGS | | | | | | | | |
|---|-------------------|------|------|------|------|--|--|--|
| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNIT | | | |
| Maximum Junction-to-Ambient | R _{thJA} | - | - | 110 | | | | |
| Maximum Junction-to-Ambient (PCB Mount) ^a | R _{thJA} | - | - | 50 | °C/W | | | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | - | 3.0 | | | | |

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

| SPECIFICATIONS (T _J = 25 °C, u PARAMETER | SYMBOL | , | T CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|---------------------|--|--|------------|-----------|----------------------|------------------|
| Static | OTMBOL | | | IVIII V. | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} = | 0 V, I _D = - 250 μA | - 200 | - | _ | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_J$ | 40 | e to 25 °C, I _D = - 1 mA | - | - 0.22 | - | V/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | | V _{GS} , I _D = - 250 μA | - 2.0 | - | - 4.0 | V |
| Gate-Source Leakage | I _{GSS} | _ | $V_{GS} = \pm 20 V$ | - | - | ± 100 | nA |
| Ĵ | | V _{DS} = | - 200 V, V _{GS} = 0 V | - | - | - 100 | |
| Zero Gate Voltage Drain Current | I _{DSS} | $\begin{array}{c c c c c c c c c c c c c c c c c c c $ | - | - 500 | μA | | |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = - 10 V | I _D = - 2.2 A ^b | - | - | 1.5 | Ω |
| Forward Transconductance | 9 _{fs} | V _{DS} = | - 50 V, I _D = - 2.2 A | 1.1 | - | - | S |
| Dynamic | | | | | | | |
| Input Capacitance | Ciss | | $V_{ee} = 0.V$ | - | 340 | - | |
| Output Capacitance | C _{oss} | | $V_{DS} = -25 V,$ | - | 110 | - | pF |
| Reverse Transfer Capacitance | C _{rss} | f = 1 | .0 MHz, see fig. 5 | - | 33 | - | |
| Total Gate Charge | Qg | | | - | - | 20 | |
| Gate-Source Charge | Q_gs | V _{GS} = - 10 V | | - | - | 3.3 | nC |
| Gate-Drain Charge | Q _{gd} | | | - | - | 11 | |
| Turn-On Delay Time | t _{d(on)} | | · | - | 8.8 | - | |
| Rise Time | t _r | V _{DD} = - | - 100 V, I _D = - 3.9 A, | - | 27 | - | - ns |
| Turn-Off Delay Time | t _{d(off)} | $R_g = \overline{18} \Omega,$ | $R_D = 24 \Omega$, see fig. 10^{b} | - | 7.3 | - | |
| Fall Time | t _f | | | - | 19 | - | |
| Internal Drain Inductance | L _D | Between lead 6 mm (0.25") | · , | - | 4.5 | - | |
| Internal Source Inductance | L _S | package and die contact | center of | - | 7.5 | - | nH |
| Drain-Source Body Diode Characteristic | s | - | | | | | |
| Continuous Source-Drain Diode Current | IS | MOSFET sym showing the | bol | - | - | - 3.6 | |
| Pulsed Diode Forward Current ^a | I _{SM} | integral revers p - n junction | | - | - | - 14 | A |
| Body Diode Voltage | V_{SD} | T _J = 25 °C, | I_{S} = - 3.6 A, V_{GS} = 0 V ^b | - | - | - 6.3 | V |
| Body Diode Reverse Recovery Time | t _{rr} | T _ 05 °O I | - 20 A dl/dt 100 A/b | - | 150 | 300 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | $I_{\rm J} = 25 {}^{-} {\rm C}, I_{\rm F}$ | = - 3.9 A, dl/dt = 100 A/μs ^b | - | 0.97 | 2.0 | μC |
| Forward Turn-On Time | t _{on} | Intrinsic tu | ırn-on time is negligible (turn | -on is dor | ninated b | y L _S and | L _D) |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

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IRFR9220, IRFU9220, SiHFR9220, SiHFU9220

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

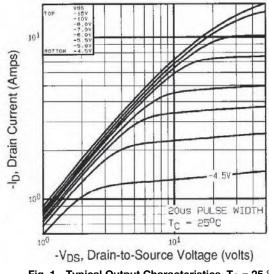


Fig. 1 - Typical Output Characteristics, T_C = 25 $^\circ C$

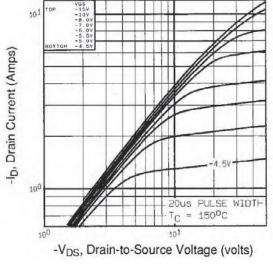
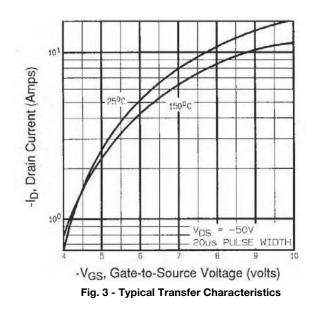


Fig. 2 - Typical Output Characteristics, T_C = 150 °C



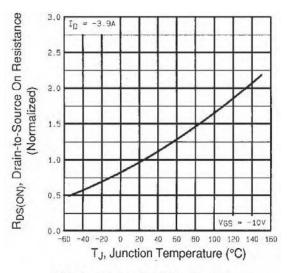


Fig. 4 - Normalized On-Resistance vs. Temperature



IRFR9220, IRFU9220, SiHFR9220, SiHFU9220

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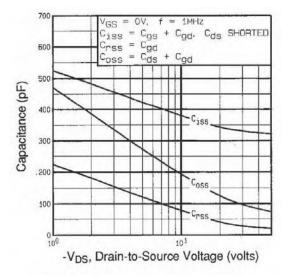


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

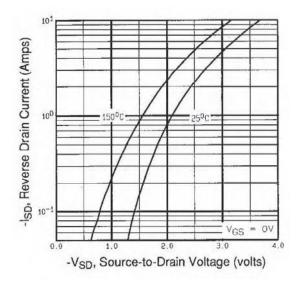


Fig. 7 - Typical Source-Drain Diode Forward Voltage

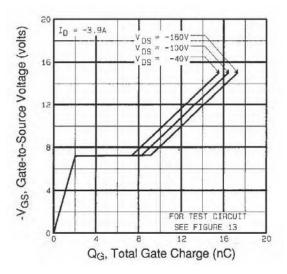


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

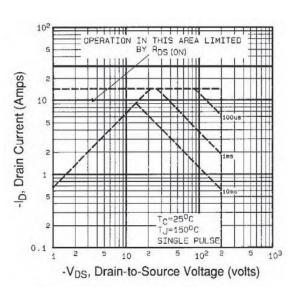


Fig. 8 - Maximum Safe Operating Area



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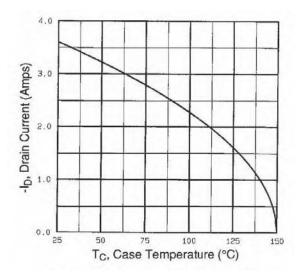


Fig. 9 - Maximum Drain Current vs. Case Temperature

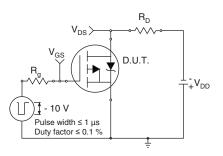


Fig. 10a - Switching Time Test Circuit

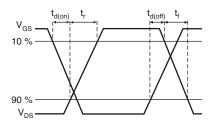


Fig. 10b - Switching Time Waveforms

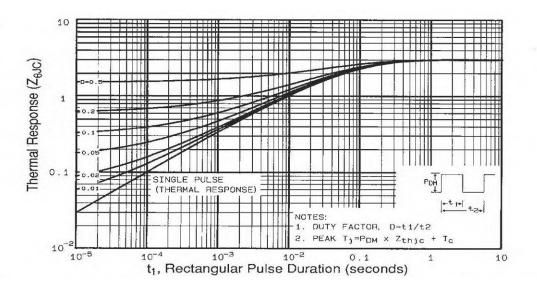


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case





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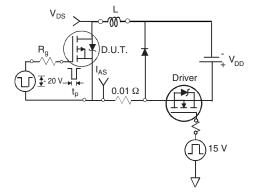


Fig. 12a - Unclamped Inductive Test Circuit

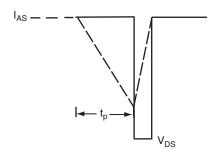


Fig. 12b - Unclamped Inductive Waveforms

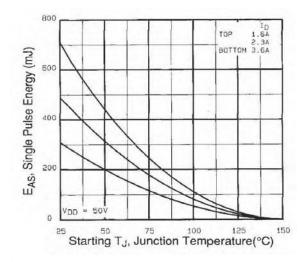
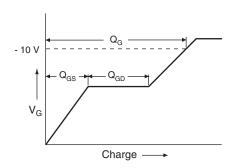


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





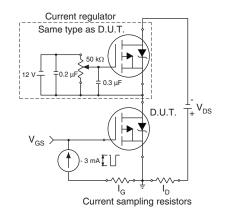


Fig. 13b - Gate Charge Test Circuit

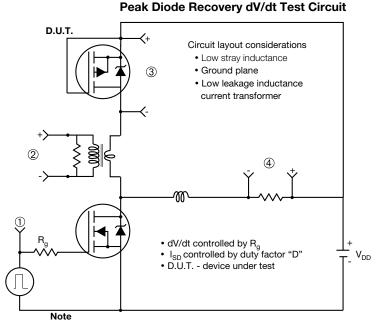
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• Compliment N-Channel of D.U.T. for driver

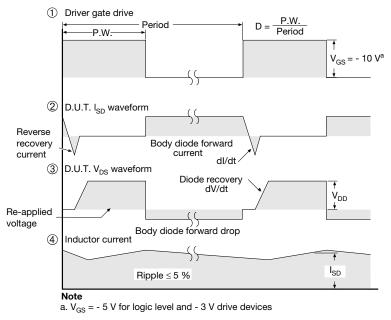
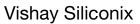


Fig. 14 - For P-Channel

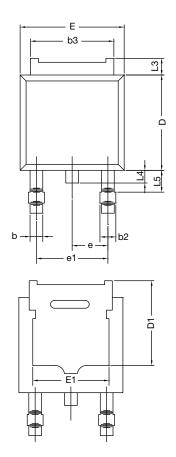
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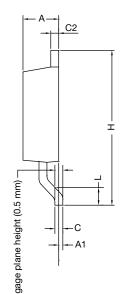
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TO-252AA Case Outline





| | MILLIN | IETERS | INC | HES | | | |
|-----------------------|--------------------------------|-----------|-----------|-------|--|--|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | | | |
| А | 2.18 | 2.38 | 0.086 | 0.094 | | | |
| A1 | - | 0.127 | - | 0.005 | | | |
| b | 0.64 | 0.88 | 0.025 | 0.035 | | | |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 | | | |
| b3 | 4.95 | 5.46 | 0.195 | 0.215 | | | |
| С | 0.46 | 0.61 | 0.018 | 0.024 | | | |
| C2 | 0.46 | 0.89 | 0.018 | 0.035 | | | |
| D | 5.97 | 6.22 | 0.235 | 0.245 | | | |
| D1 | 4.10 | - | 0.161 | - | | | |
| Е | 6.35 | 6.73 | 0.250 | 0.265 | | | |
| E1 | 4.32 | - | 0.170 | - | | | |
| Н | 9.40 | 10.41 | 0.370 | 0.410 | | | |
| е | 2.28 | BSC | 0.090 BSC | | | | |
| e1 | 4.56 | BSC | 0.180 BSC | | | | |
| L | 1.40 | 1.78 | 0.055 | 0.070 | | | |
| L3 | 0.89 | 1.27 | 0.035 | 0.050 | | | |
| L4 | - | 1.02 | - | 0.040 | | | |
| L5 | 1.01 | 1.52 | 0.040 | 0.060 | | | |
| ECN: T16- DWG: 534 | 0236-Rev. P, [•] 7 | 16-May-16 | | | | | |

Notes

• Dimension L3 is for reference only.



Vishay Siliconix

TO-251AA (HIGH VOLTAGE)



| | MILLI | METERS | INC | HES | | MILLI | METERS | INC | HES |
|------|-------|--------|-------|-------|------|-------|--------|-------|-----|
| DIM. | MIN. | MAX. | MIN. | MAX. | DIM. | MIN. | MAX. | MIN. | MA |
| А | 2.18 | 2.39 | 0.086 | 0.094 | D1 | 5.21 | - | 0.205 | - |
| A1 | 0.89 | 1.14 | 0.035 | 0.045 | E | 6.35 | 6.73 | 0.250 | 0.2 |
| b | 0.64 | 0.89 | 0.025 | 0.035 | E1 | 4.32 | - | 0.170 | - |
| b1 | 0.65 | 0.79 | 0.026 | 0.031 | е | 2.29 | BSC | 2.29 | BSC |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 | L | 8.89 | 9.65 | 0.350 | 0.3 |
| b3 | 0.76 | 1.04 | 0.030 | 0.041 | L1 | 1.91 | 2.29 | 0.075 | 0.0 |
| b4 | 4.95 | 5.46 | 0.195 | 0.215 | L2 | 0.89 | 1.27 | 0.035 | 0.0 |
| с | 0.46 | 0.61 | 0.018 | 0.024 | L3 | 1.14 | 1.52 | 0.045 | 0.0 |
| c1 | 0.41 | 0.56 | 0.016 | 0.022 | θ1 | 0' | 15' | 0' | 15 |
| c2 | 0.46 | 0.86 | 0.018 | 0.034 | θ2 | 25' | 35' | 25' | 35 |
| D | 5.97 | 6.22 | 0.235 | 0.245 | | • | • | • | |

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.



Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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